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Steven J. Elleman

41,733
Reg. No.

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Applicant : Thomas Wiegele, et al.
Serial No. : 10/620,119
Filed : July 15, 2003
Title : MICRO MIRROR ARRAYS AND MICROSTRUCTURES WITH
SOLDERABLE CONNECTION SITES
Docket : 015559-288
Art Unit : 2874

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NOTICE OF SUBSEQUENT FOREIGN OR INTERNATIONAL FILING

Pursuant to 35 U.S.C. §132(b)(2)(B)(iii), applicant hereby notifies the Office that applicant has filed applications directed to the invention disclosed in this application in foreign countries or under a multilateral international agreement. Applicant has also submitted a Request to Rescind Previous Non-publication Request.

Respectfully submitted,

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